TEXAS INSTRUMENTS

10UT [

1IN- 🛛 2

1IN+ 🛛 3

V_{CC} [] 4

2IN+ 🛛 5

2IN- 🚺 6

20UT [

1

7

D, N, OR PW PACKAGE

(TOP VIEW)

14 40UT

13 4IN-

10 3IN+

GND

1 30UT

12 4IN+

11

9 3IN-

8

FEATURES

- Low Supply Current . . . 85 μA Typ
- Low Offset Voltage . . . 2 mV Typ
- Low Input Bias Current . . . 2 nA Typ
- Input Common Mode to GND
- Wide Supply Voltage . . . 3 V < V_{CC} < 32 V
- Pin Compatible With LM324
- Applications
 - LCD Displays
 - Portable Instrumentation
 - Sensor/Metering Equipment
 - Consumer Electronics (MP3 Players, Toys, Etc.)
 - Power Supplies

DESCRIPTION/ORDERING INFORMATION

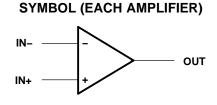
The LP324 and LP2902 are quadruple low-power operational amplifiers especially suited for battery-operated applications. Good input specifications and wide supply-voltage range still are achieved, despite the ultra-low supply current. Single-supply operation is achieved with an input common-mode range that includes GND.

The LP324 and LP2902 are ideal in applications where wide supply voltage and low power are more important than speed and bandwidth. These applications include portable instrumentation, LCD displays, consumer electronics (MP3 players, toys, etc.), and power supplies.

T _A	P	ACKAGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
	PDIP – N	Tube of 25	LP324N	LP324N		
	SOIC – D	Tube of 50	LP324D	LP324		
0°C to 70°C	50IC - D	Reel of 2500	LP324DR	- LP324		
	TSSOP – PW	Tube of 90	LP324PW	LP324		
	1330P - PW	Reel of 2000	LP324PWR	- LP324		
	PDIP – N	Tube of 25	LP2902N	LP2902N		
	SOIC – D	Tube of 50	LP2902D	LP2902		
–40°C to 85°C	50IC - D	Reel of 2500	LP2902DR	LP2902		
	TSSOP – PW	Tube of 50	LP2902PW	1 02002		
	13306 - 80	Reel of 2500	LP2902PWR	- LP2902		

ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



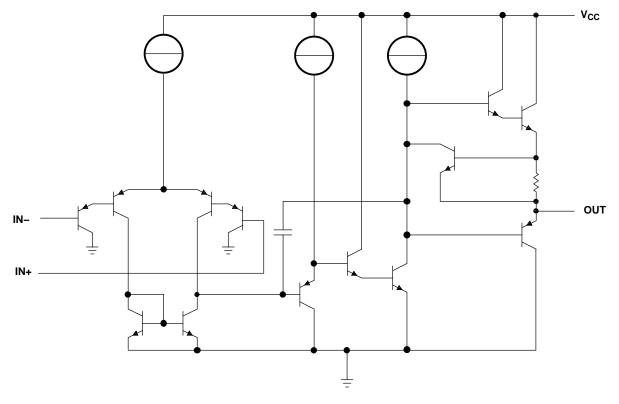
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SLOS460A-MARCH 2005-REVISED MAY 2005

SCHEMATIC (EACH AMPLIFIER)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT	
V _{CC}	Supply voltage range ⁽²⁾		±16 or 32	V		
V _{ID}	Differential input voltage ⁽³⁾			±32	V	
VI	Input voltage (either input)	-0.3	32	V		
	Duration of output short circuit (one amplifier) to		Unlimited			
		D package		86		
θ_{JA}	Package thermal impedance ⁽⁵⁾⁽⁶⁾	N package		80	°C/W	
		PW package		113		
TJ	Operating virtual junction temperature		150	°C		
T _{stg}	Storage temperature range		-65	150	°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.

(3) Differential voltages are at IN+, with respect to IN-.

(4) Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.

- (5) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

(b) The package thermal impedance is calculated in accordance with JESD 51

ESD Protection

TEST CONDITIONS	ТҮР	UNIT
Human-Body Model	±2	kV

SLOS460A-MARCH 2005-REVISED MAY 2005

Electrical Characteristics

 $\rm T_{A}$ = 25°C, $\rm V_{CC}$ = 5 V, $\rm V_{IC}$ = $\rm V_{CC}/2, \, R_{L}$ = 100 k Ω to GND (unless otherwise noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾	T _A (2)	L	.P324		LI	P2902		UNIT	
		TEST CONDITIONS	'A'-'	MIN	TYP ⁽³⁾	MAX	MIN	TYP ⁽³⁾	MAX	UNIT	
	lanut offentueltere		25°C		2	4		2	4		
V _{IO}	Input offset voltage		Full range			9			10	mV	
	lanut bing sumant		25°C		2	10		2	20	0	
I _{IB}	Input bias current		Full range			20			40	nA	
	have the first summer t		25°C		0.2	2		0.5	4		
I _{IO}	Input offset current		Full range			4			8	nA	
•	Large-signal	$R_{I} = 10 k\Omega$ to GND,	25°C	50	100		40	70		\//\/	
A _V	voltage gain	$V_{CC}^{L} = 30 V$	Full range	40			30			V/mV	
	Common-mode	$V_{CC} = 30 V_{,}$	25°C	80	90		80	90			
CMRR	CMRR rejection ratio	$V_{IC} = 0 V \text{ to } V_{CC} - 1.5 V$	Full range	75			75			dB	
	Power-supply		25°C	80	90		80	90			
k _{VSR}	rejection ratio	$V_{CC} = 5 V \text{ to } 30 V$	Full range	75			75			V	
I _{CC} Supply current	<u>_</u>	25°C		85	150		85	150			
	R _L = ∞	Full range			250			275	μA		
	Output voltage	$I_1 = 0.35 \text{ mA to GND},$	25°C	3.4	3.6		3.4	3.6		v	
V _{OH}	swing (high)	$V_{IC} = 0 V$	Full range	V _{CC} – 1.9			V _{CC} – 1.9				
.,	Output voltage	$I_L = 0.35 \text{ mA from } V_{CC},$	25°C	0.82	0.7		0.82	0.7			
V _{OL}	swing (low)	$V_{IC} = 0 V$	Full range	1			1			V	
	Output source		25°C	7	10		7	10			
I _O	current	$V_{O} = 3 V, V_{ID} = 1 V$	Full range	4			4			mA	
			25°C	4	5		4	5			
		$V_{O} = 1.5 V, V_{ID} = -1 V$	Full range	3			3				
I _O	Output sink current	$V_{O} = 1.5 \text{ V}, V_{ID} = -1 \text{ V},$	25°C	2	4		2	4		mA	
		$V_{IC} = 0 V$	Full range	1			1				
			25°C		20	35		20	35		
I _{OS,GND}	Output short to GND	$V_{ID} = 1 V$	Full range			40			40	mA	
	Output shart to M		25°C		15	30		15	30		
los,vcc	Output short to V_{CC}	$V_{ID} = -1 V$	Full range			45			45	mA	
∝V _{IO}	Input offset voltage drift		25°C		10			10		μV/°C	
∝I _{IO}	Input offset current drift		25°C		10			10		pA/∘C	

For full-range temperature limits: V_{CC} = 3 V to 32 V, V_{ICR} = 0 V to V_{CC} − 1.5 V (unless otherwise noted)
 Full range is 0°C to 70°C for LP324 and −40°C to 85°C for LP2902.
 All typical values are at T_A = 25°C.

Operating Conditions

 $V_{CC} = \pm 15 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$

	PARAMETER					
GBW	Gain bandwidth product	100	kHz			
SR	Slew rate	50	V/ms			



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2902D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LP2902	Samples
LP2902DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LP2902	Samples
LP2902N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	LP2902N	Samples
LP2902PW	ACTIVE	TSSOP	PW	14	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LP2902	Samples
LP2902PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LP2902	Samples
LP2902PWRE4	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LP2902	Samples
LP324D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LP324	Samples
LP324DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	0 to 70	LP324	Samples
LP324DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LP324	Samples
LP324N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	LP324N	Samples
LP324PW	ACTIVE	TSSOP	PW	14	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LP324	Samples
LP324PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LP324	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.



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PACKAGE OPTION ADDENDUM

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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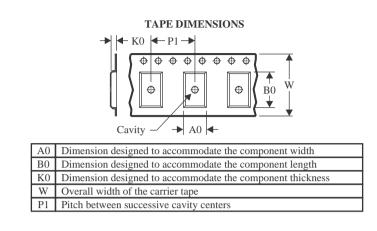


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STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2902DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LP2902PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LP324DR	SOIC	D	14	2500	330.0	16.8	6.5	9.5	2.1	8.0	16.0	Q1
LP324DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LP324DRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LP324PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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PACKAGE MATERIALS INFORMATION

3-Jun-2022



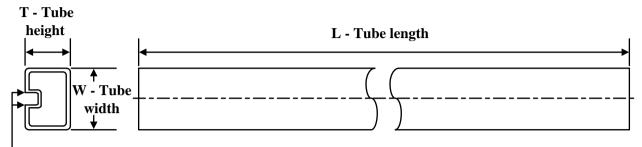
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2902DR	SOIC	D	14	2500	340.5	336.1	32.0
LP2902PWR	TSSOP	PW	14	2000	356.0	356.0	35.0
LP324DR	SOIC	D	14	2500	364.0	364.0	27.0
LP324DR	SOIC	D	14	2500	340.5	336.1	32.0
LP324DRG4	SOIC	D	14	2500	340.5	336.1	32.0
LP324PWR	TSSOP	PW	14	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

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3-Jun-2022

TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
LP2902D	D	SOIC	14	50	507	8	3940	4.32
LP2902N	N	PDIP	14	25	506	13.97	11230	4.32
LP2902PW	PW	TSSOP	14	90	530	10.2	3600	3.5
LP324D	D	SOIC	14	50	507	8	3940	4.32
LP324N	N	PDIP	14	25	506	13.97	11230	4.32
LP324PW	PW	TSSOP	14	90	530	10.2	3600	3.5

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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